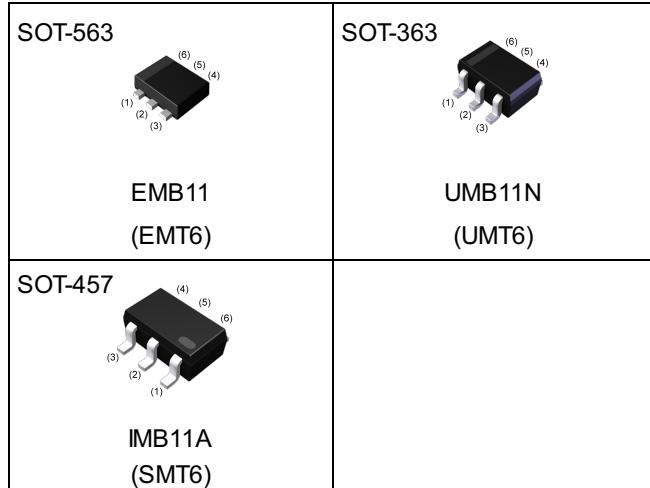


Parameter	DTr1 and DTr2
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	10kΩ
R <sub>2</sub>	10kΩ

## ●Features

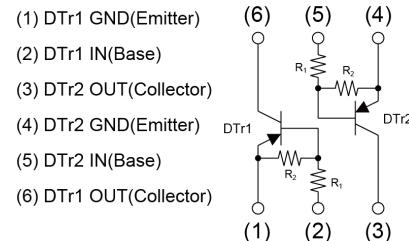
- 1)Two DTA114E chips in a EMT or UMT or SMT package.
- 2)Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

## ●Outline

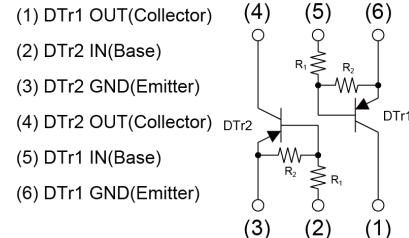


## ●Inner circuit

EMB11 / UMB11N



IMB11A



## ●Application

INVERTER, INTERFACE, DRIVER

## ●Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMB11	SOT-563 (EMT6)	1616	T2R	180	8	8000	B11
UMB11N	SOT-363 (UMT6)	2021	TN	180	8	3000	B11
IMB11A	SOT-457 (SMT6)	2928	T110	180	8	3000	B11

● **Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )**

<For DTr1 and DTr2 in common>

Parameter	Symbol	Values	Unit
Supply voltage	$V_{CC}$	-50	V
Input voltage	$V_{IN}$	-40 to 10	V
Output current	$I_O$	-50	mA
Collector current	$I_{C(MAX)}^{*1}$	-100	mA
Power dissipation	EMB11	$P_D^{*2*3}$	150
	UMB11N	$P_D^{*2*3}$	150
	IMB11A	$P_D^{*2*4}$	300
Junction temperature	$T_j$	150	$^\circ\text{C}$
Range of storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

● **Electrical characteristics ( $T_a = 25^\circ\text{C}$ )**

<For DTr1 and DTr2 in common>

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input voltage	$V_{I(off)}$	$V_{CC} = -5\text{V}, I_O = -100\mu\text{A}$	-	-	-0.5	V
	$V_{I(on)}$	$V_O = -0.3\text{V}, I_O = -10\text{mA}$	-3.0	-	-	
Output voltage	$V_{O(on)}$	$I_O = -10\text{mA}, I_I = -0.5\text{mA}$	-	-100	-300	mV
Input current	$I_I$	$V_I = -5\text{V}$	-	-	-880	$\mu\text{A}$
Output current	$I_{O(off)}$	$V_{CC} = -50\text{V}, V_I = 0\text{V}$	-	-	-500	nA
DC current gain	$G_I$	$V_O = -5\text{V}, I_O = -5\text{mA}$	30	-	-	-
Input resistance	$R_I$	-	7	10	13	$\text{k}\Omega$
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-
Transition frequency	$f_T^{*1}$	$V_{CE} = -10\text{V}, I_E = 5\text{mA}, f = 100\text{MHz}$	-	250	-	MHz

\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.

\*3 120mW per element must not be exceeded.

\*4 200mW per element must not be exceeded.

● Electrical characteristic curves ( $T_a = 25^\circ\text{C}$ )  
 <For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current  
 (ON Characteristics)

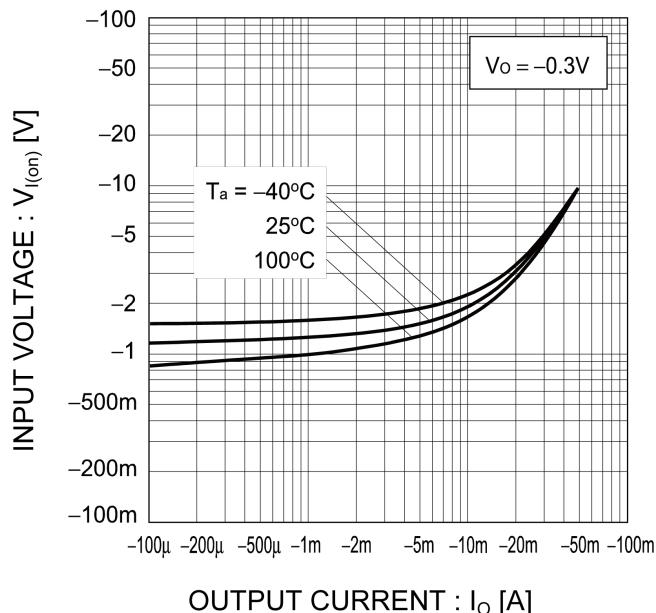


Fig.2 Output Current vs. Input Voltage  
 (OFF Characteristics)

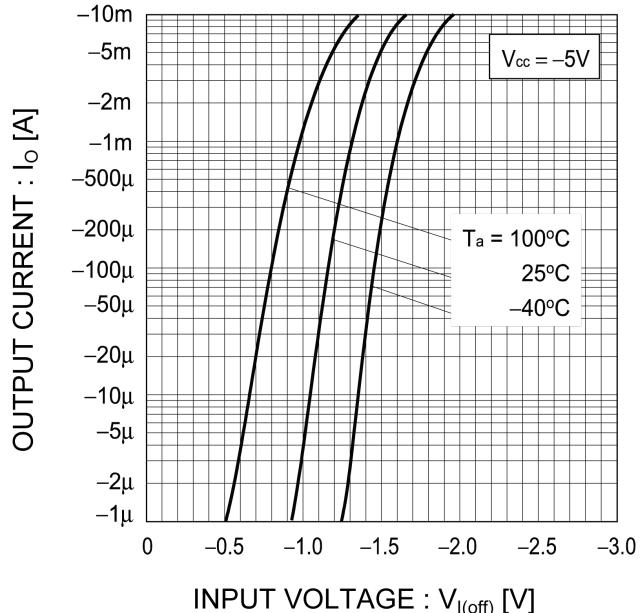


Fig.3 Output Current vs. Output Voltage

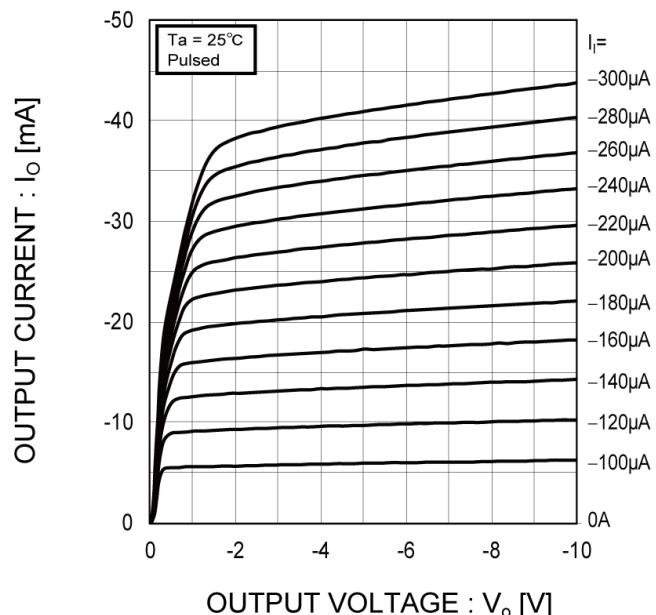
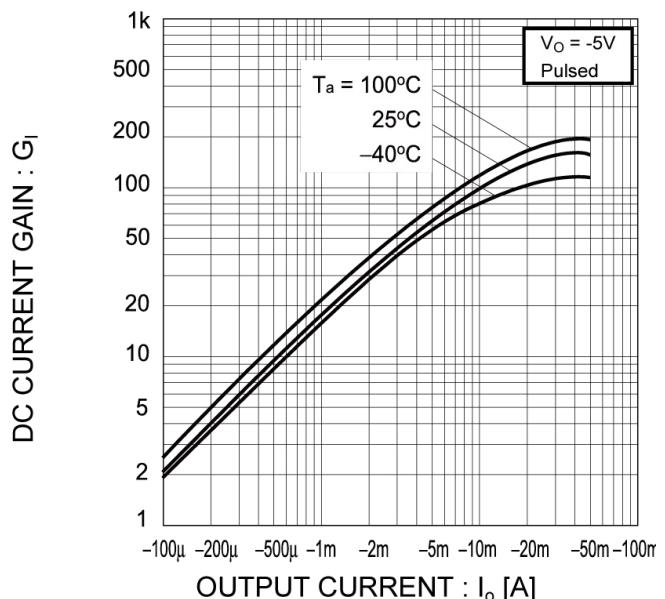


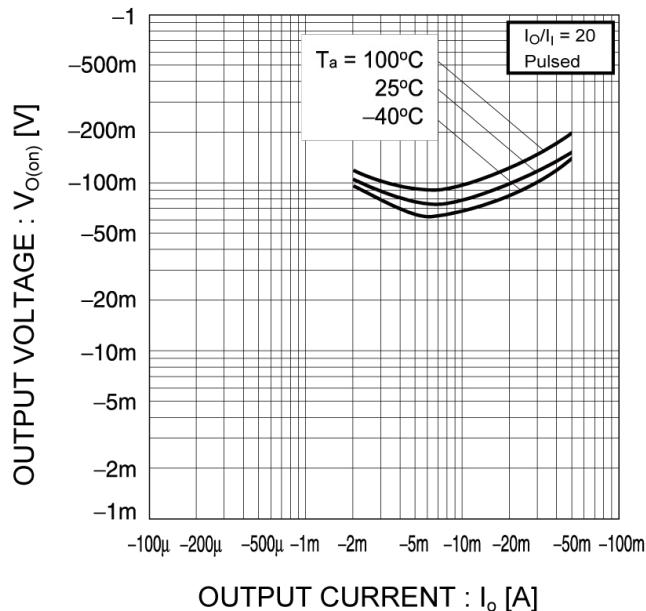
Fig.4 DC Current Gain vs. Output Current



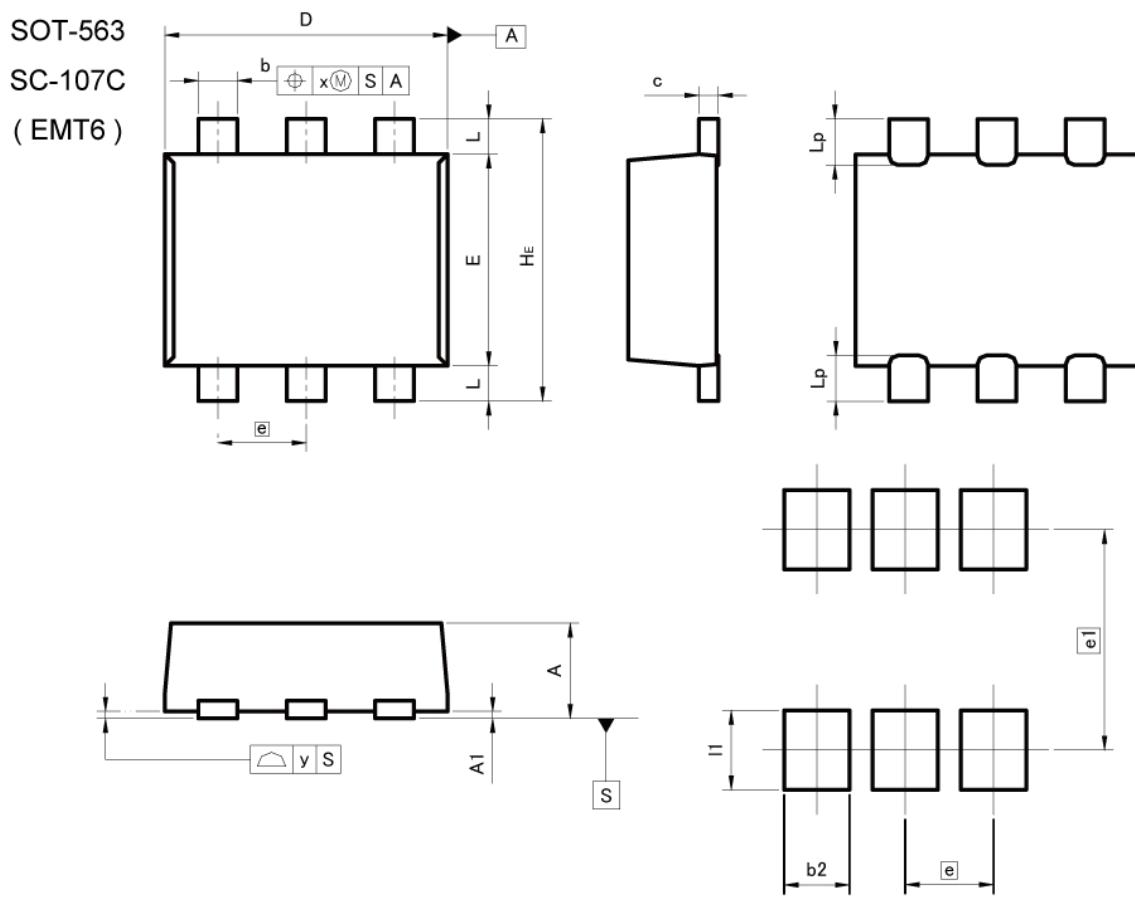
**● Electrical characteristic curves ( $T_a = 25^\circ\text{C}$ )**

&lt;For DTr1 and DTr2 in common&gt;

Fig.5 Output Voltage vs. Output Current



## ●Dimensions



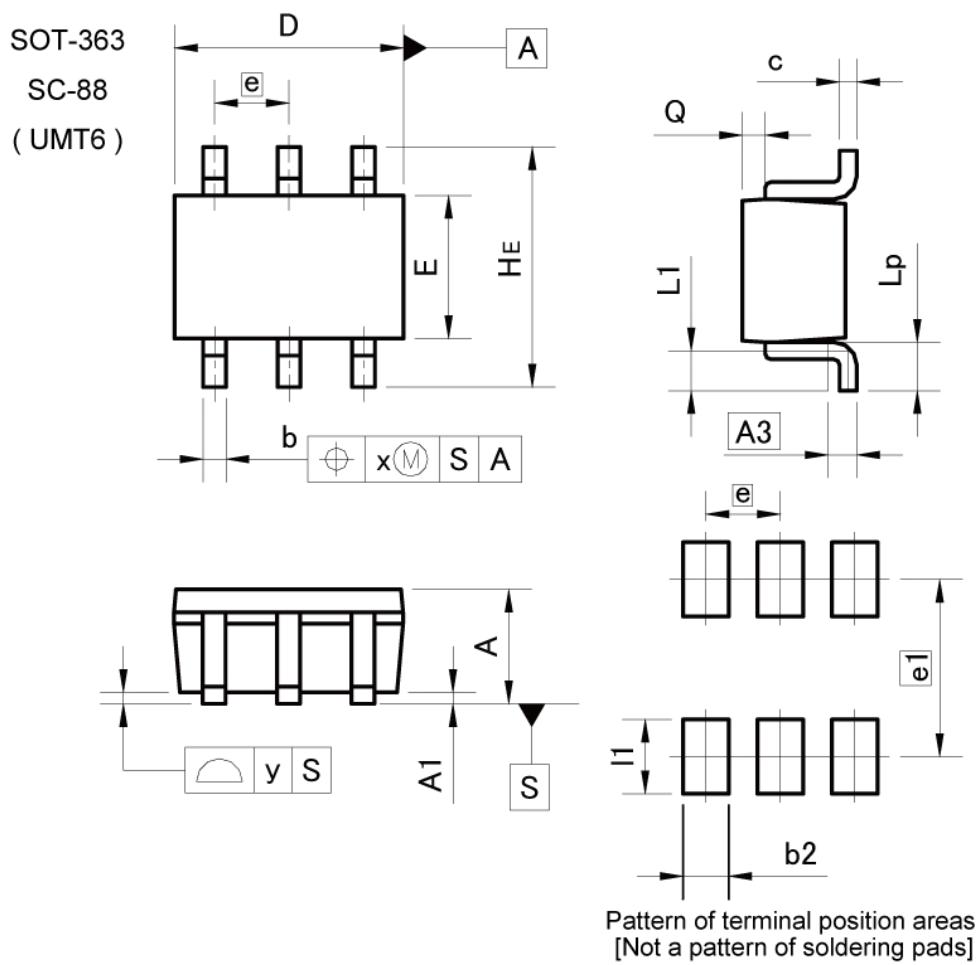
Pattern of terminal position areas  
[Not a pattern of soldering pads]

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
c	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
e	0.50		0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	—	0.35	—	0.014
x	—	0.10	—	0.004
y	—	0.10	—	0.004

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	—	0.37	—	0.015
e1	1.25		0.049	
l1	—	0.45	—	0.018

Dimension in mm/inches

## ●Dimensions

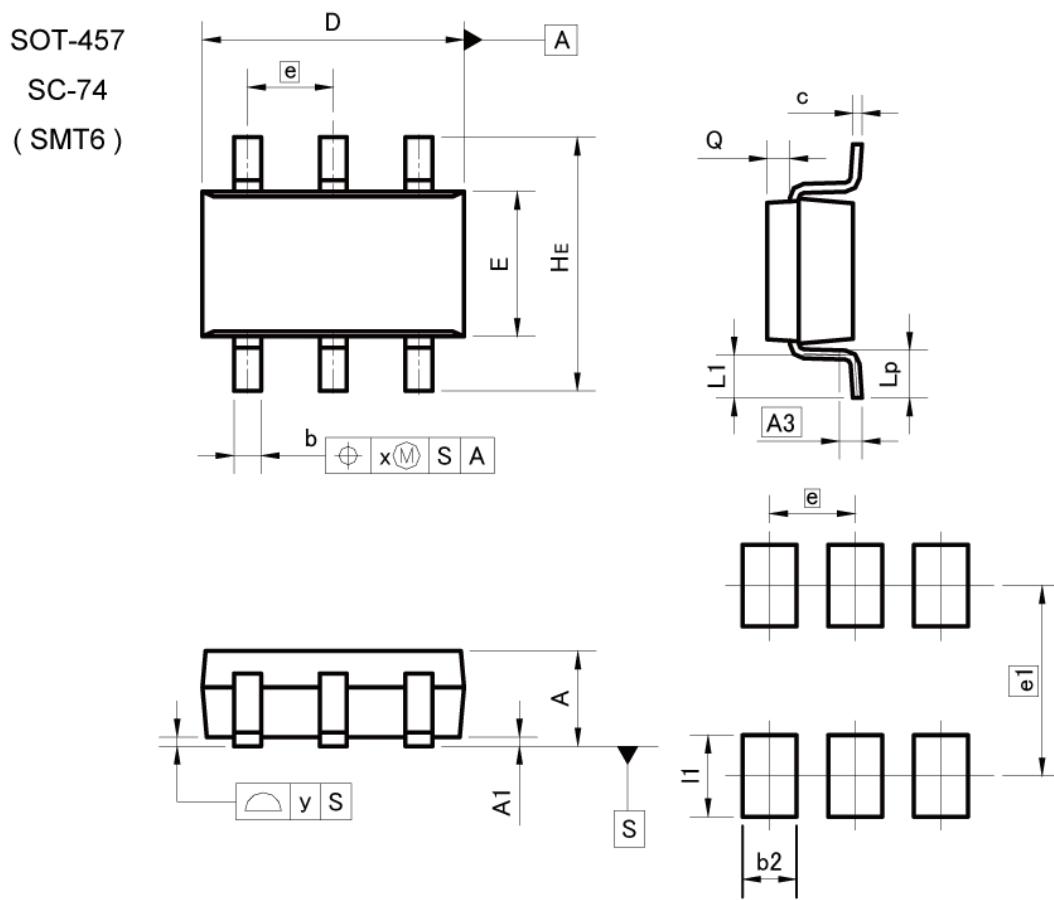


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.15	0.30	0.006	0.012
c	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
x	—	0.10	—	0.004
y	—	0.10	—	0.004

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	—	0.40	—	0.016
e1	1.55		0.061	
l1	—	0.65	—	0.026

Dimension in mm/inches

## ●Dimensions



Pattern of terminal position areas  
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
c	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
e	0.95		0.037	
He	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x	—	0.20	—	0.008
y	—	0.10	—	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2		0.60	—	0.024
e1	2.10		0.083	
l1	—	0.90	—	0.035

Dimension in mm/inches

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